

# RClamp0531Z Ultra Small RClamp® 1-Line, 5V ESD Protection

## PROTECTION PRODUCTS

## Description

RailClamp® TVS arrays are ultra low capacitance ESD protection devices designed to protect high speed data interfaces. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

RClamp®0531Z has a typical capacitance of only 0.30pF. This allows it to be used on circuits operating in excess of 5GHz without signal attenuation.

RClamp0531Z is in a 2-pin SLP0603P2X3B package. It measures 0.6 x 0.3 mm with a nominal height of only 0.25mm. The leads are finished with lead-free NiAu. Each device will protect one line operating at 5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and RF modules.

### **Features**

- High ESD withstand Voltage: +/-12kV (Contact) and +/- 15kV (Air) per IEC 61000-4-2
- Able to withstand over 1000 ESD strikes per IEC61000-4-2 Level 4
- Ultra-small 0201 package
- Protects one high-speed data line
- Working voltage: +/- 5V
- Low capacitance: 0.30 pF typical
- Low leakage current: <5 nA typical (V<sub>p</sub>=5V)
- Extremely low dynamic resistance: 0.67 Ω (Typ.)
- Solid-state silicon-avalanche technology

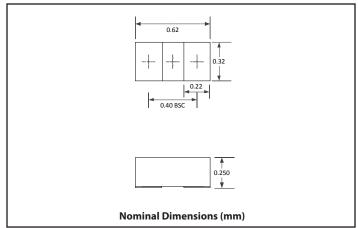
## **Mechanical Characteristics**

- SLP0603P2X3B package
- Pb-Free, Halogen Free, RoHS/WEEE compliant
- Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- Lead Finish: NiAu
- Marking: Marking code + dot matrix date code
- Packaging: Tape and Reel

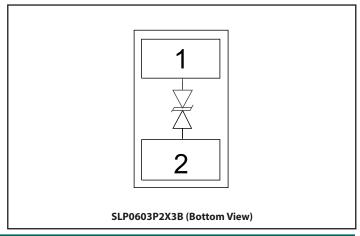
## **Applications**

- · RF Antenna and Modules
- FM Antenna
- USB 2.0
- MHL
- GPS

## **Package Dimension**



## **Schematic & Pin Configuration**



# **Absolute Maximum Rating**

Rating	Symbol	Value	Units
Peak Pulse Power (tp = $8/20\mu s$ )	P <sub>PK</sub>	60	W
Peak Pulse Current (tp = 8/20μs)	I <sub>PP</sub>	3	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V <sub>ESD</sub>	±15 ±12	kV
Operating Temperature	T,	-55 to +125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics (T=25°C unless otherwise specified)**

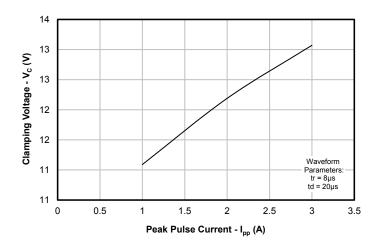
Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Pin 1 to 2 or 2 to 1				5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>BR</sub> = 1 mA, Pin 1 to 2 or 2 to 1		7	9	11	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, Pin 1 to 2 or 2 to 1			5	20	nA
Clamping Voltage	V <sub>c</sub>	tp = 8/20μs	$I_{pp} = 1A$			15	V
			$I_{pp} = 3A$			20	
ESD Clamping Voltage <sup>2</sup> $V_{c}$ $tp = 0.2/100 ns$	V	h. 0.2/100	$I_{pp} = 4A$		13		
	tp = 0.2/100ns	I <sub>pp</sub> = 16A		21		V	
Dynamic Resistance <sup>2,3</sup>	R <sub>DYN</sub>	tp = 0.2/100ns			0.67		Ω
Junction Capacitance	C <sub>J</sub>	$V_R = 0V$ to 5V, $f = 1MHz$			0.30	0.40	
Junction Capacitance 4	C <sub>J</sub>	$V_R = 0V$ to 5V, $f = 1$ GHz				0.40	pF
Change in Capacitance Over V <sub>R</sub> <sup>4</sup>	$\Delta C_{JVR}$	$V_R = 0V$ to 5V, $f = 1MHz$				0.040	

#### Notes

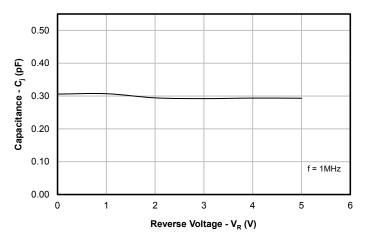
- 1) ESD gun return path connected to ESD ground plane.
- 2) Transmission Line Pulse Test (TLP) Settings: tp = 100ns, tr = 0.2ns,  $I_{TLP}$  and  $V_{TLP}$  averaging window:  $t_1 = 70$ ns to  $t_2 = 90$ ns.
- 3) Dynamic resistance calculated from  $I_{\text{TLP}} = 4A$  to  $I_{\text{TLP}} = 16A$
- 4) Guaranteed by design. Not production tested.

# **Typical Characteristics**

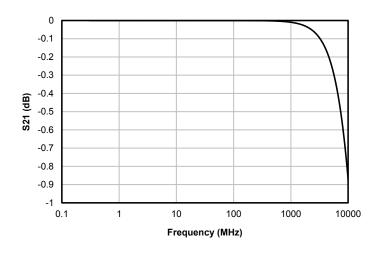
## Clamping Voltage vs. Peak Pulse Current



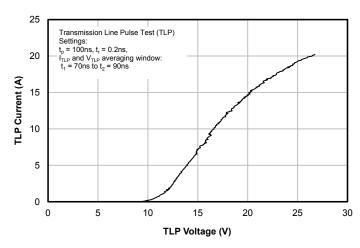
#### **Junction Capacitance vs. Reverse Voltage**



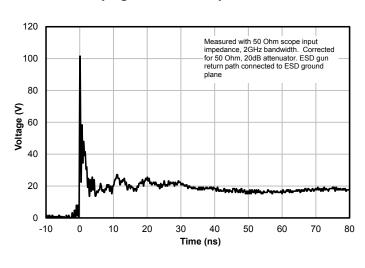
## **Typical Insertion Loss (S21)**



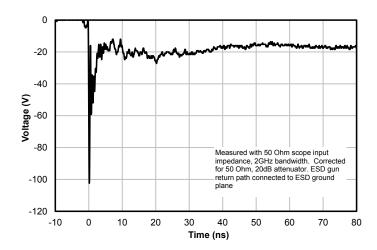
**TLP Characteristic** 



ESD Clamping (+8kV Contact per IEC 61000-4-2)



ESD Clamping (-8kV Contact per IEC 61000-4-2)



## **Application Information**

## **Assembly Guidelines**

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joints. The figure at the right details Semtech's recommended mounting pattern. Recommended assembly guidelines are shown in Table 1. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. Exact manufacturing parameters will require some experimentation to get the desired solder application.

#### **Solder Stencil**

Stencil design is one of the key factors which will determine the volume of solder paste which is deposited onto the land pad. The area ratio of the stencil aperture will determine how well the stencil will print. The area ratio takes into account the aperture shape, aperture size, and stencil thickness. A minimum area ratio of 0.66 is preferred for the subject package. The area ratio of a rectangular aperture is given as:

Area Ratio = (L \* W) / (2 \* (L + W) \* T)

#### Where:

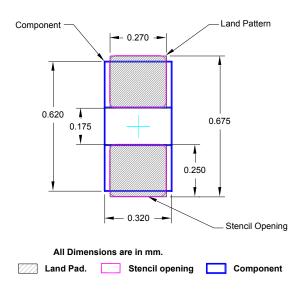
L = Aperture Length

W = Aperture Width

T = Stencil Thickness

Semtech recommends a stencil with square aperture and rounded corners for consistent solder release. The stencil should be laser cut with electropolished finish. A stencil thickness of 0.075mm (0.003") is recommended. A 0.100mm (0.004") stencil may be used, however the stencil opening may need to be increased slightly to achieve the desired area ratio to ensure proper solder coverage on the pad.

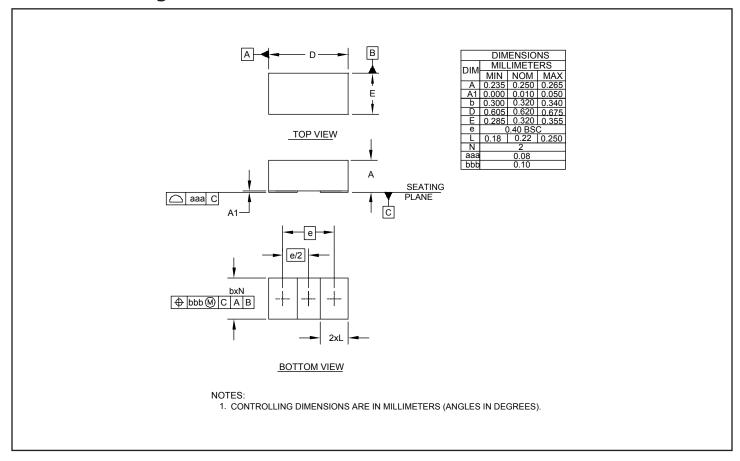
## **Recommended Mounting Pattern**



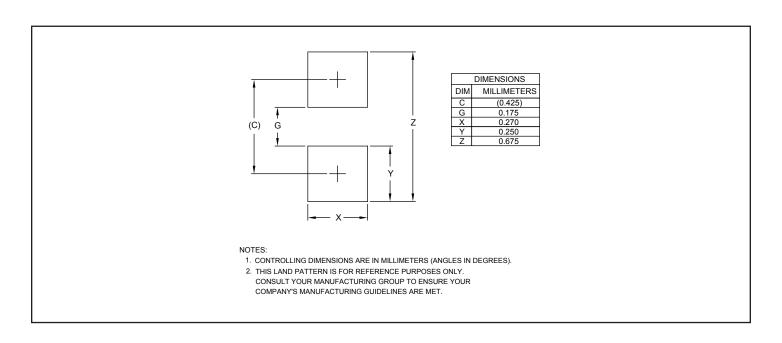
**Table 1 - Assembly Guidelines** 

Assembly Parameter	Recommendation
Solder Stencil Design	Laser Cut, Electro-Polished
Aperture Shape	Rectangular with Rounded Corners
Solder Stencil Thickness	0.075mm (0.003") or 0.100mm (0.004")
Solder Paste Type	Type 4 Size Sphere or Smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Solder Mask Defined
PCB Pad Finish	OSP or NiAu

# **Outline Drawing - SLP0603P2X3B**



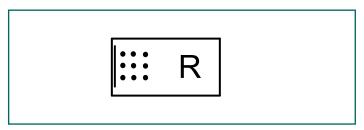
## Land Pattern - SLP0603P2X3B



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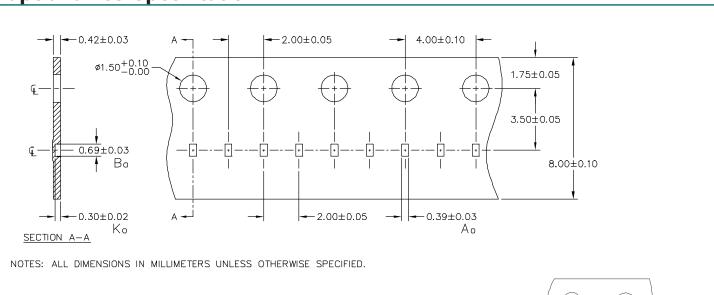
# **Marking Code**



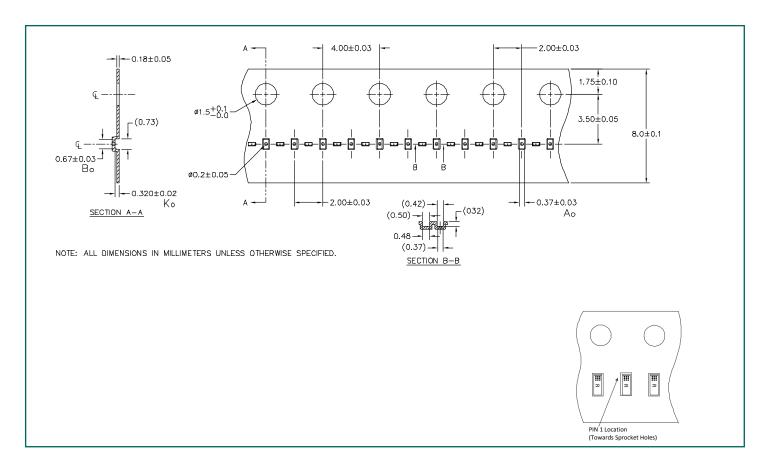
Notes:

1. Dots represent date code matrix and Pin 1 location.

**Tape and Reel Specification** 



# **Tape and Reel Specification- Plastic Tape**



# **Ordering Information**

Part Number	<b>Qty per Reel</b>	Carrier Tape	Reel Size	Comments
RClamp0531Z.TFT	15,000	Paper	7"	
RClamp0531Z.TNT	10,000	Plastic	7"	Not recommended for new designs

RClamp0531Z Final Datasheet Revision Date



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